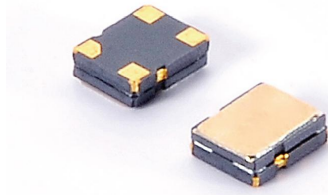


TCXO



4 Pad Version 3.2×2.5 mm

- $\pm 0.5 \sim \pm 2.5$ ppm stability
- Ultra-miniature package
- Clipped sine wave
- Low power consumption
- Reflow soldering temperature: 260°C max

RoHS
2002/95/

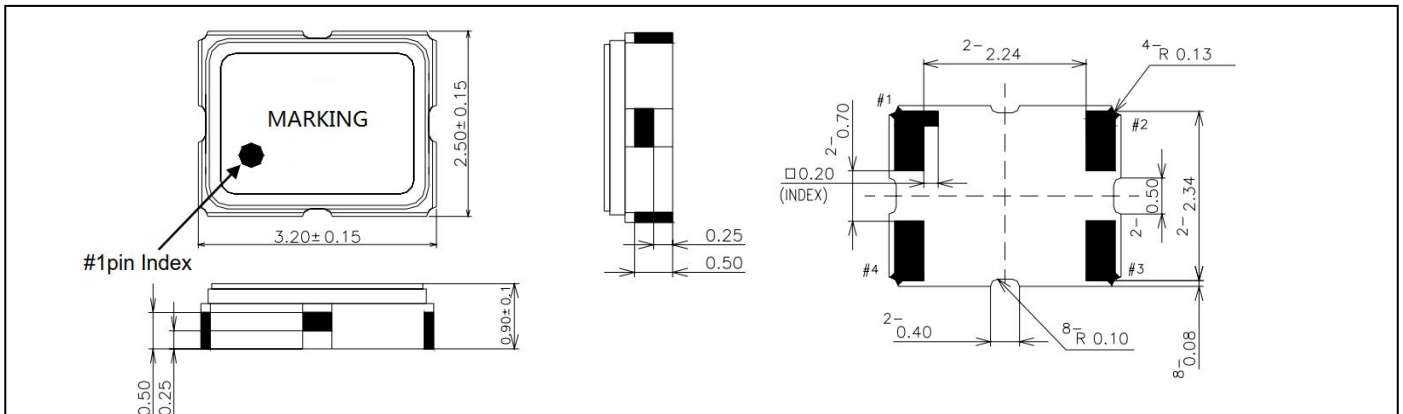
RoHS compliant

★ PARAMETERS

PARAMETERS	SPECIFICATION
Frequency Range	13.0~50.0MHz
Supply Voltage	1.8V、2.5V、2.8V、3.3V
Supply Current	13MHz≤F0≤26MHz: 1.5mA max 26MHz<F0≤50MHz: 2.0mA max
Frequency Tolerance	±1.0ppm、±1.5ppm、±2.0ppm
Frequency Stability	Vs Temperature (ref. to +25℃) ±0.5~±2.5ppm
	Vs Supply voltage change (±5%) ±0.2ppm
	Vs Load change (±10%) ±0.2ppm
	Vs Aging (1 st Year ,25±2℃) ±1.0ppm
Operating Temp. Range	-30~+85℃、-40~+85℃
Storage Temp. Range	-55~+125℃
Output Waveform:	Clipped Sine Wave
Output Level:	0.8 Vp-p Min (Clipped Sine Wave)
Output Load	10K Ω //10pF
Symmetry	45% ~ 55% typ. at 0.5×Vdc
Start-up Time	2.0mS max
Phase Noise	-115 dBc/Hz max @100Hz offset
	-135 dBc/Hz max @1KHz offset
	-148 dBc/Hz max @10KHz offset

○ All specification subject change without notice.

★ DIMENSIONS& LAND PATTERN LAYOUT (Unit: mm)

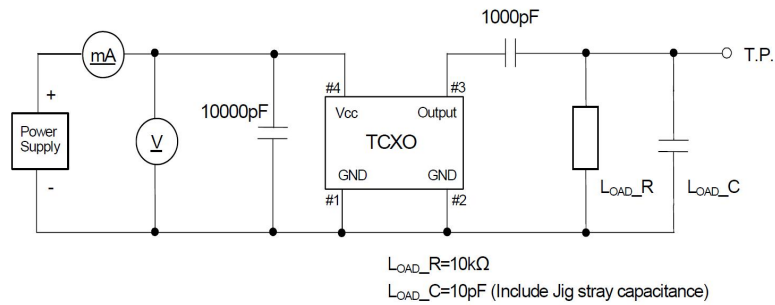


★ PART NUMBER GUIDE e.g. FTO26.000M3.0SM3- 1.0/2.5C (*SM3=3.2×2.5 SMD TYPE)

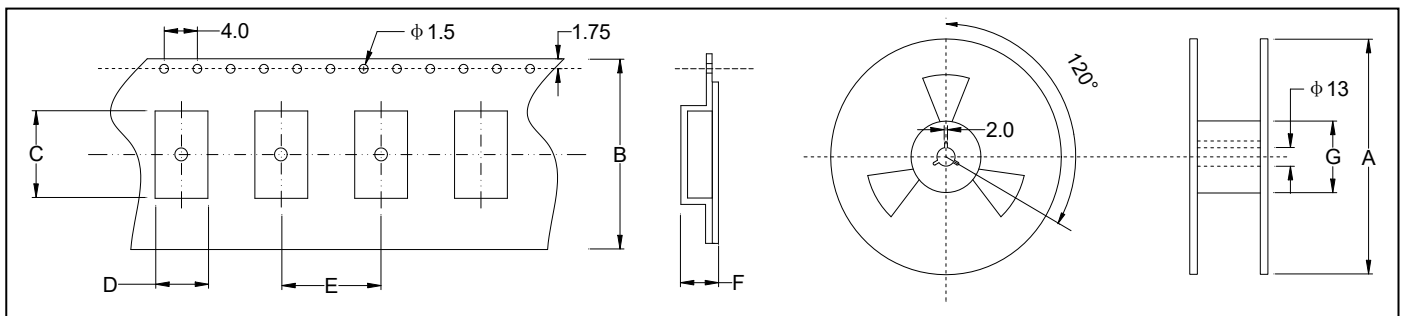
Logo	TCXO	Frequency	Supply voltage V	Package	Frequency Tolerance PPM	Frequency Stability PPM	Operating Temp.
F	TO	26.000M	3.0	SM3	1.0	2.5	C

Definition	Description
Operating Temp.	A: -10~+70℃
	B: -20~+80℃
	C: -30~+85℃
	D: -40~+85℃
	E: Customer specified

★ TEST CIRCUIT

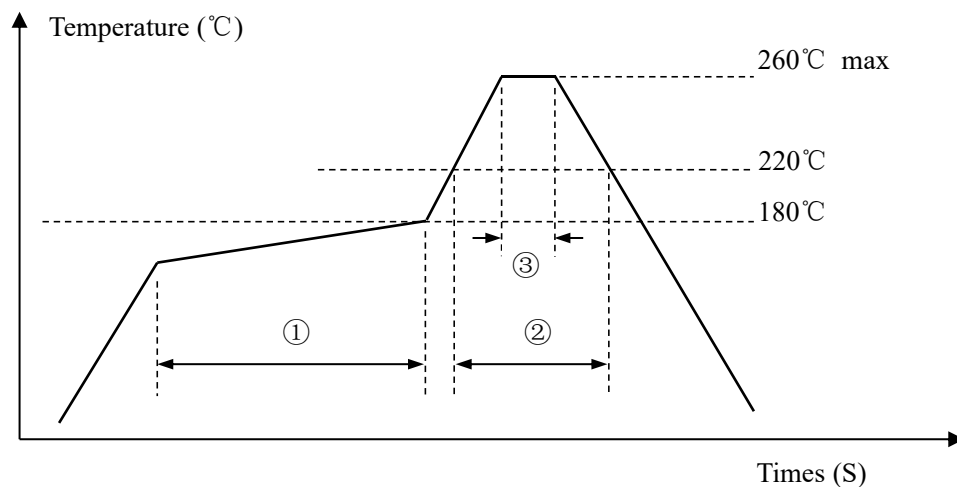


★ TAPING SPECIFICATION (Unit: mm)



	A	B	C	D	E	F	G
OSC-SMD3225	178 ± 2.0	8.0 ± 0.3	3.55 ± 0.10	2.80 ± 0.10	4.0 ± 0.1	1.4 ± 0.1	60.5 ± 1.0
2000 pcs per reel							

★ REFLOW SOLDERING PROFILE



Pb free reflow A	①	Preheat	160~180℃	120sec. max
	②	Primary heat	220℃	60sec. max
	③	Peak	260℃	10sec. max.